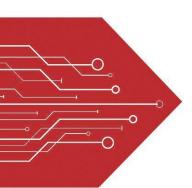
MSKSEMI















ESD

TVS

TSS

MOV

GDT

PLED

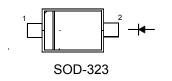
Broduct data speet



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Features

- Fast switching speed
- Ultra-small surface mount package
- For general purpose switching applications
- High conductance



RNNING

PIN	DESCRIPTION
1	Cathode
2	Anode
	<u> </u>

MARK:T4

Absolute Maximum Ratings (T_a = 25 °C)

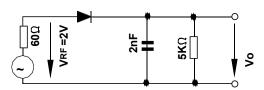
Parameter	Symbol	Value	Unit
Peak Reverse Voltage	V _{RM}	100	V
Reverse Voltage	V _R	75	V
Average Rectified Forward Current	I _{F(AV)}	150	mA
Non-repetitive Peak Forward Surge Current at t = 1 μs	I _{FSM}	2	Α
Power Dissipation	P _{tot}	400	mW
Thermal Resistance from Junction to Ambient Air	$R_{\theta JA}$	312	°C/W
Junction Temperature	Tj	150	°C
Storage Temperature Range	T _{stg}	- 65 to + 150	°C

Characteristics at T_a = 25 °C

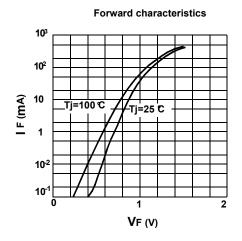
Parameter	Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at I _R = 1 μA	$V_{(BR)R}$	75	-	V
Forward Voltage at I_F = 1 mA at I_F = 50 mA at I_F = 150 mA	V _F		0.715 0.855 1 1.25	>
Peak Reverse Current at V_R = 75 V at V_R = 20 V at V_R = 75 V, T_J = 150 °C at V_R = 25 V, T_J = 150 °C	I _R	- - -	1 25 50 30	μΑ nA μΑ μΑ
Total Capacitance at $V_R = 0 V$, $f = 1 MHz$	Ст	-	2	pF
Reverse Recovery Time at I_{rr} = 0.1 X I_R , I_F = I_R = 10 mA, R_L = 100 Ω	t _{rr}	-	4	ns

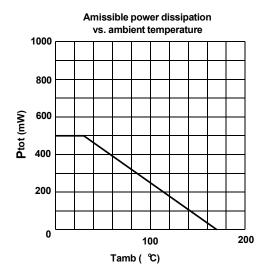


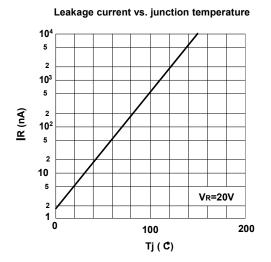


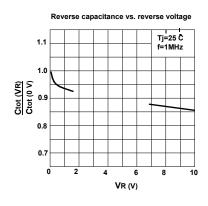


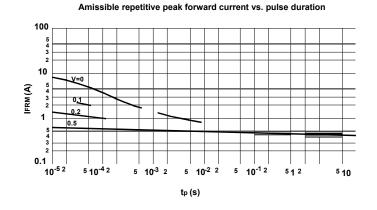
Rectification Efficiency Measurement Circuit









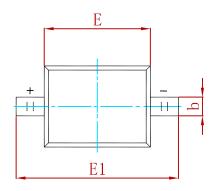


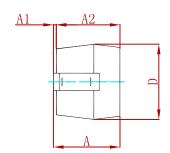


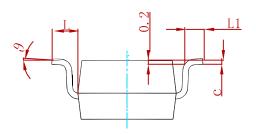
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PACKAGE MECHANICAL DATA

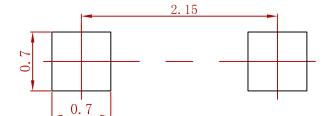






Cumbal	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min.	Max.	Min.	Max.
Α		1.000		0.039
A1	0.000	0.100	0.000	0.004
A2	0.800	0.900	0.031	0.035
b	0.250	0.350	0.010	0.014
С	0.080	0.150	0.003	0.006
D	1.200	1.400	0.047	0.055
E	1.600	1.800	0.063	0.071
E1	2.550	2.750	0.100	0.108
L	0.475 REF.		0.019	REF.
L1	0.250	0.400	0.010	0.016
θ	0°	8°	0°	8°

Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
1N4148WS-MS	SOD-323	3000



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